



## Miniature, 1W Isolated REGULATED DC/DC CONVERTERS

### FEATURES

- UL1950 RECOGNIZED
- DIP-18, SO-28
- 53W/in<sup>3</sup> (3.3W/cm<sup>3</sup>) POWER DENSITY
- DEVICE-TO-DEVICE SYNCHRONIZATION
- THERMAL PROTECTION
- 1000Vrms ISOLATION
- 400kHz SWITCHING
- 125 FITS AT 55°C
- ±10% INPUT RANGE
- SHORT-CIRCUIT PROTECTED
- 5V, 12V, 24V INPUTS
- 3.3V, 5V OUTPUTS
- HIGH EFFICIENCY

### APPLICATIONS

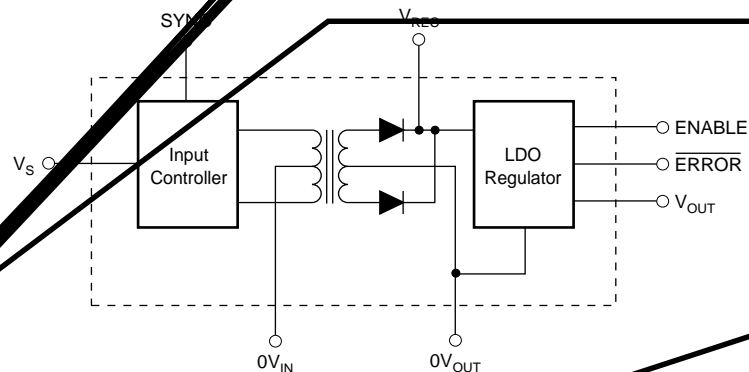
- POINT-OF-USE POWER CONVERSION
- DIGITAL INTERFACE POWER
- GROUND LOOP ELIMINATION
- POWER-SUPPLY NOISE REDUCTION

### DESCRIPTION

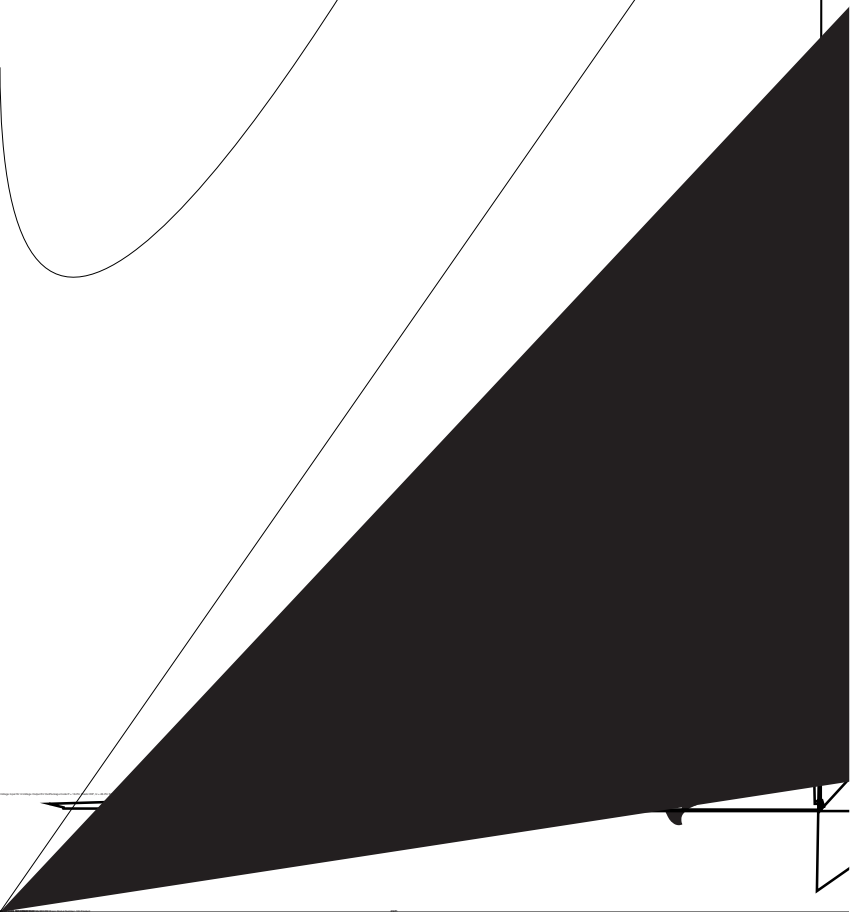
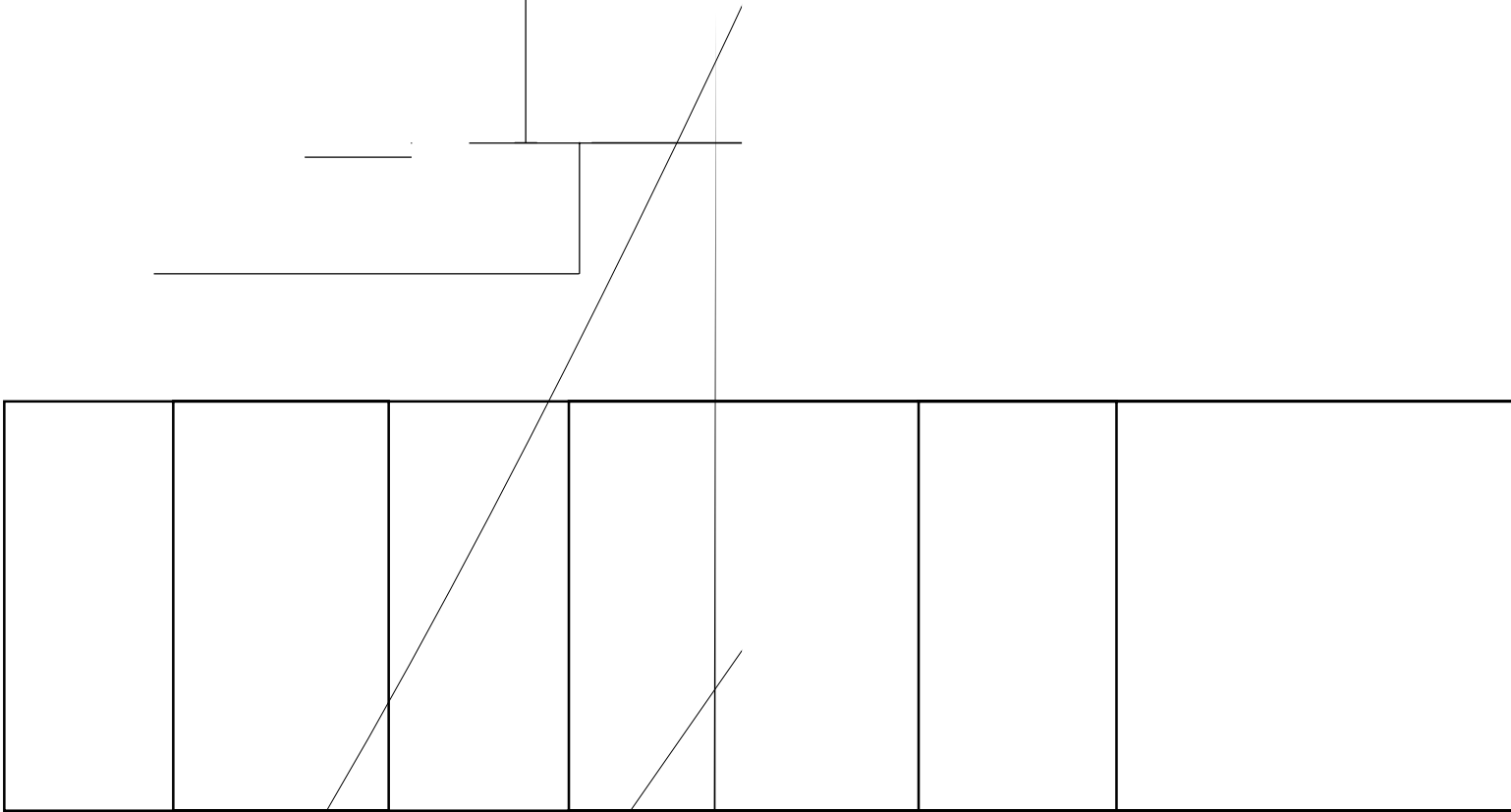
The DCR01 family is a series of high-efficiency, input-isolated, output-regulated DC/DC converters. In addition to 1W nominal, galvanically-isolated output power capability, this range of DC/DCs offer very low output noise, thermal protection, and high accuracy.

The DCR01 family is implemented in standard molded IC packaging, giving standard JEDEC outlines suitable for high-volume assembly.

The DCR01 is manufactured using the same technology as standard IC packages, thereby achieving very high reliability.



This integrated circuit can be damaged by ESD. Texas Instru-





# ELECTRICAL CHARACTERISTICS (Cont.)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = \text{nominal}$ ,  $I_O = 10\text{mA}$ ,  $C_O = 0.1\mu\text{F}$ , unless otherwise specified.

PARAMETER	CONDITIONS	DCR01 SERIES			UNITS
		MIN	TYP	MAX	
Supply Current					
DCR010503P	$I_O = 0\text{mA}$		18		mA
	$I_O = 10\text{mA}$		28		mA
	$I_O = 300\text{mA}$		335		mA
DCR010503U	$I_O = 0\text{mA}$		24		mA
	$I_O = 10\text{mA}$		33		mA
	$I_O = 300\text{mA}$		339		mA
DCR010505P	$I_O = 0\text{mA}$		25		mA
	$I_O = 10\text{mA}$		40		mA
	$I_O = 200\text{mA}$		306		mA
DCR010505U	$I_O = 0\text{mA}$		25		mA
	$I_O = 10\text{mA}$		40		mA
	$I_O = 200\text{mA}$		306		mA
DCR011203P	$I_O = 0\text{mA}$		13		mA
	$I_O = 10\text{mA}$		17		mA
	$I_O = 390\text{mA}$		173		mA
DCR011203U	$I_O = 0\text{mA}$		13		mA
	$I_O = 10\text{mA}$		17		mA
	$I_O = 390\text{mA}$		136		mA
DCR011205P	$I_O = 0\text{mA}$		13		mA
	$I_O = 10\text{mA}$		18		mA
	$I_O = 200\text{mA}$		125		mA
DCR011205U	$I_O = 0\text{mA}$		14		mA
	$I_O = 10\text{mA}$		19		mA
	$I_O = 200\text{mA}$		123		mA
DCR012403P	$I_O = 0\text{mA}$		17		mA
	$I_O = 10\text{mA}$		18		mA
	$I_O = 390\text{mA}$		97		mA
DCR012403U	$I_O = 0\text{mA}$		15		mA
	$I_O = 10\text{mA}$		17		mA
	$I_O = 390\text{mA}$		75		mA
DCR012405P	$I_O = 0\text{mA}$		15		mA
	$I_O = 10\text{mA}$		18		mA
	$I_O = 200\text{mA}$		69		mA
DCR012405U	$I_O = 0\text{mA}$		15		mA
	$I_O = 10\text{mA}$		18		mA
	$I_O = 200\text{mA}$		67		mA
Reflected Ripple Current	20MHz Bandwidth, 100% Load $C_{IN} = 2.2\mu\text{F}$ , $C_{FILTER} = 1\mu\text{F}$		8		mAp-p
<b>ISOLATION</b>					
Voltage	1s Flash Test	1			kVrms
	60s Test, UL1950 <sup>(2)</sup>	1			kVrms
Input/Output Capacitance			25		pF
<b>OUTPUT ENABLE CONTROL</b>					
Logic High Input Voltage	$2.0 < V_{ENABLE} < V_{REC}$	2.0		$V_{REC}$	V
Logic High Input Current			100		nA
Logic Low Input Voltage		-0.2		0.5	V
Logic Low Input Current	$0 < V_{ENABLE} < 0.5$		100		nA
$V_{REC}$	All 3.3V Outputs		3.3		V
$V_{REC}$	All 5V Outputs		5		V
<b>ERROR FLAG</b>					
Logic High Open Collector Leakage	$V_{ERROR} = 5\text{V}$			10	$\mu\text{A}$
Logic Low Output Voltage	Sinking 2mA			0.4	V
<b>THERMAL SHUTDOWN</b>					
Junction Temperature					
Temperature Activated			150		$^\circ\text{C}$
Temperature Deactivated			130		$^\circ\text{C}$
<b>SYNCHRONIZATION PIN</b>					
Max External Capacitance on SYNC Pin				3	pF
Internal Oscillator Frequency			800	880	kHz
External Synchronization Frequency			720	880	kHz
External Synchronization Signal High		2.5	2.5	5.0	V
External Synchronization Signal Low		0		0.4	V
<b>TEMPERATURE RANGE</b>					
Operating		-40		+85	$^\circ\text{C}$

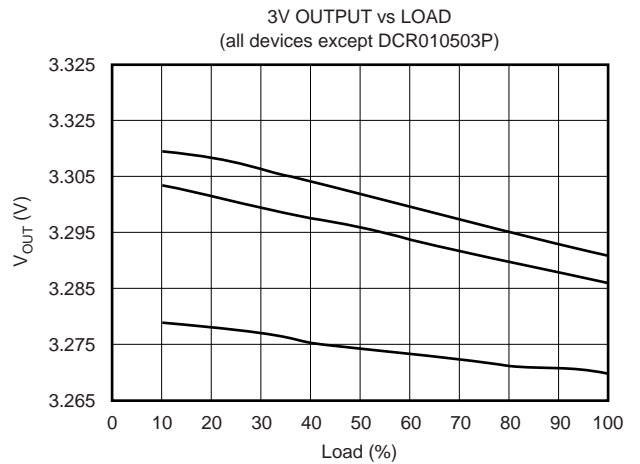
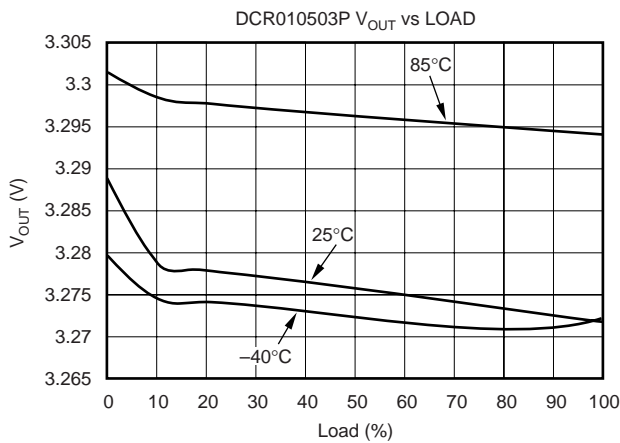
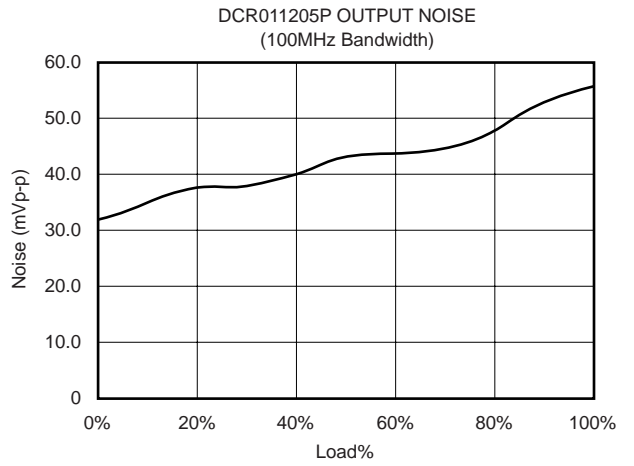
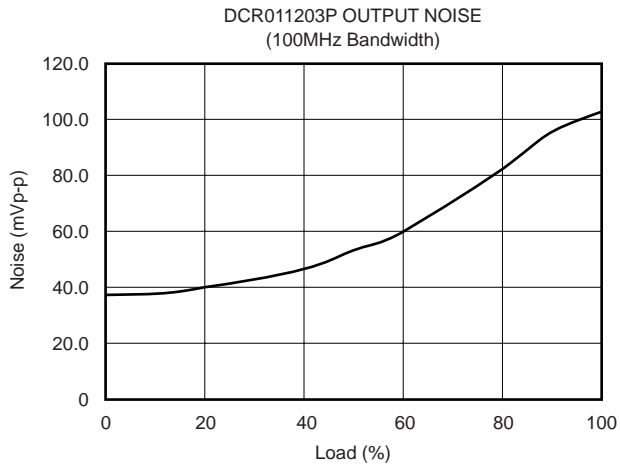
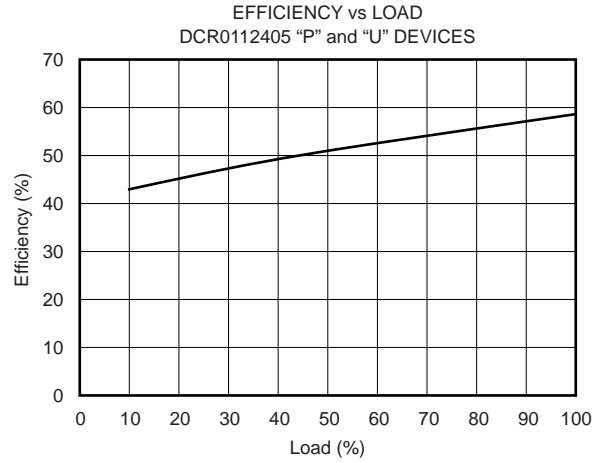
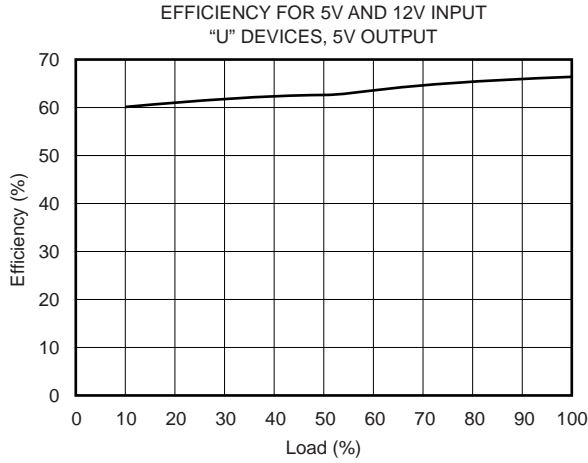
NOTES: (1)  $C_{IN} = 2.2\mu\text{F}$ ,  $C_{FILTER} = 1\mu\text{F}$ ,  $C_{OUT} = 0.1\mu\text{F}$ . (2) During UL approval only.





# TYPICAL CHARACTERISTICS (Cont.)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $I_O = 10\text{mA}$ ,  $C_{\text{FILTER}} = 1\mu\text{F}$ ,  $C_O = 0.1\mu\text{F}$ , unless otherwise specified.



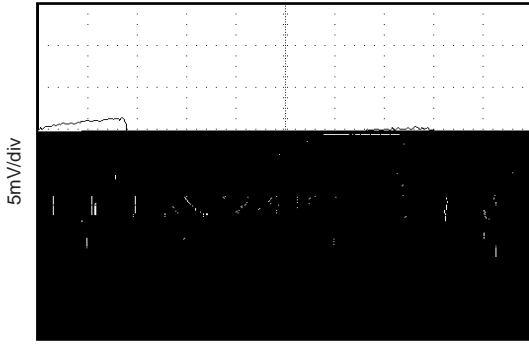




# TYPICAL CHARACTERISTICS (Cont.)

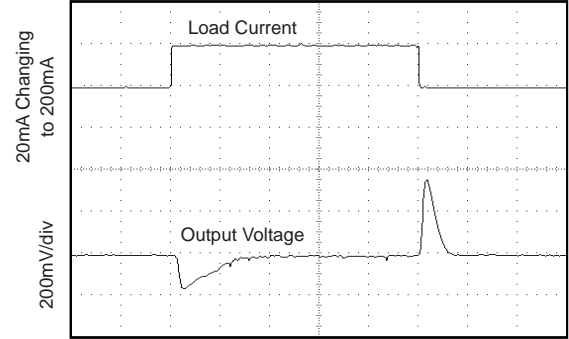
At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $I_O = 10\text{mA}$ ,  $C_{\text{FILTER}} = 1\mu\text{F}$ ,  $C_O = 0.1\mu\text{F}$ , unless otherwise specified.

DCR010503P OUTPUT VOLTAGE RIPPLE  
AT 100% LOAD (20MHz Bandwidth)



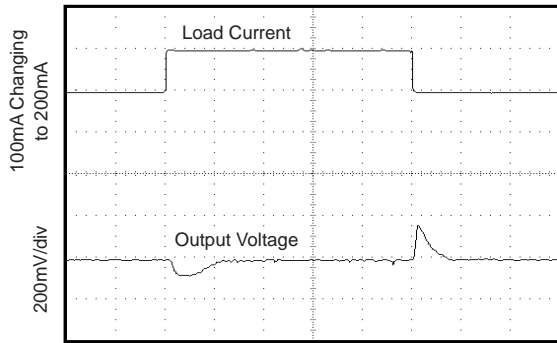
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DCR010505P LOAD TRANSIENT RESPONSE



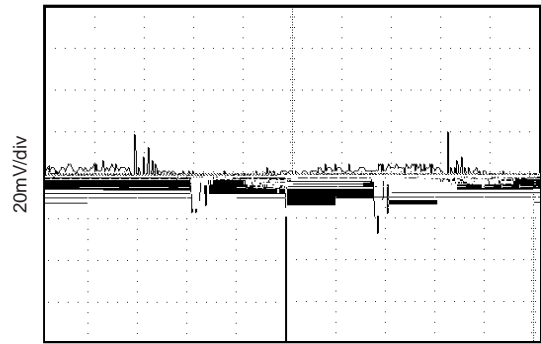
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DCR010505P LOAD TRANSIENT RESPONSE



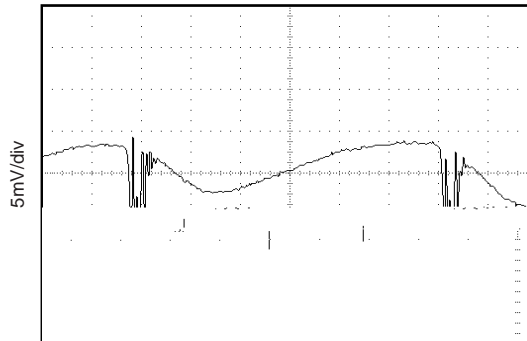
10µs/div

DCR010505P OUTPUT VOLTAGE NOISE  
AT 100% LOAD (100MHz Bandwidth)

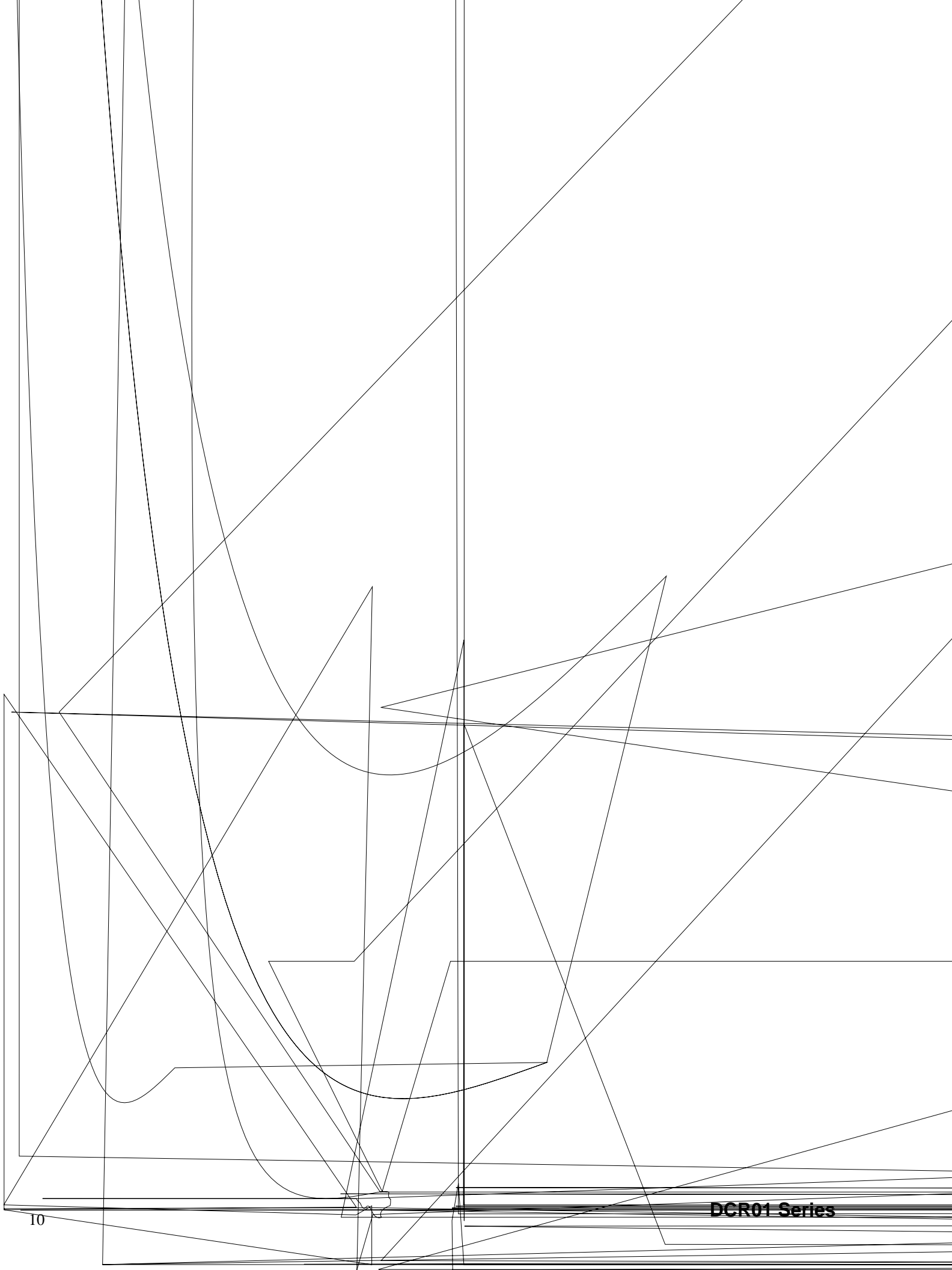


200ns/div

DCR010505P OUTPUT VOLTAGE RIPPLE  
AT 100% LOAD (20MHz Bandwidth)



200ns/div









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## PACKAGE OPTION ADDENDUM

28-Aug-2010

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Peak Temp <sup>(3)</sup>	Samples (Requires Login)
DCR010503P	ACTIVE	PDIP	NVE	10	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	<a href="#">Request Free Samples</a>
DCR010503U	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR010503U/1K	ACTIVE	SOP	DVB	12	1000	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Purchase Samples</a>
DCR010503UE4	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR010505P	ACTIVE	PDIP	NVE	10	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	<a href="#">Request Free Samples</a>
DCR010505U	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR010505U/1K	ACTIVE	SOP	DVB	12	1000	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Purchase Samples</a>
DCR010505U/1KE4	ACTIVE	SOP	DVB	12	1000	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Purchase Samples</a>
DCR010505UE4	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR010505UE4	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR011203P	ACTIVE	PDIP	NVE	10	20	TBD	CU NIPDAU	Level---	<a href="#">Request Free Samples</a>
DCR011203U	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR011203U/1K	ACTIVE	SOP	DVB	12	1000	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Purchase Samples</a>
DCR011203U/1KE4	ACTIVE	SOP	DVB	12	1000	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Purchase Samples</a>
DCR011203UE4	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR011205P	ACTIVE	PDIP	NVE	10	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	<a href="#">Request Free Samples</a>
DCR011205U	ACTIVE	SOP	DVB	12	28	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Request Free Samples</a>
DCR011205U/1K	ACTIVE	SOP	DVB	12	1000	Pb-Free (RoHS)	CU NIPDAU	Level-3-260C-168 HR	<a href="#">Purchase Samples</a>
DCR011205U/1KE4	ACTIVE	SOP	DVB						

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**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

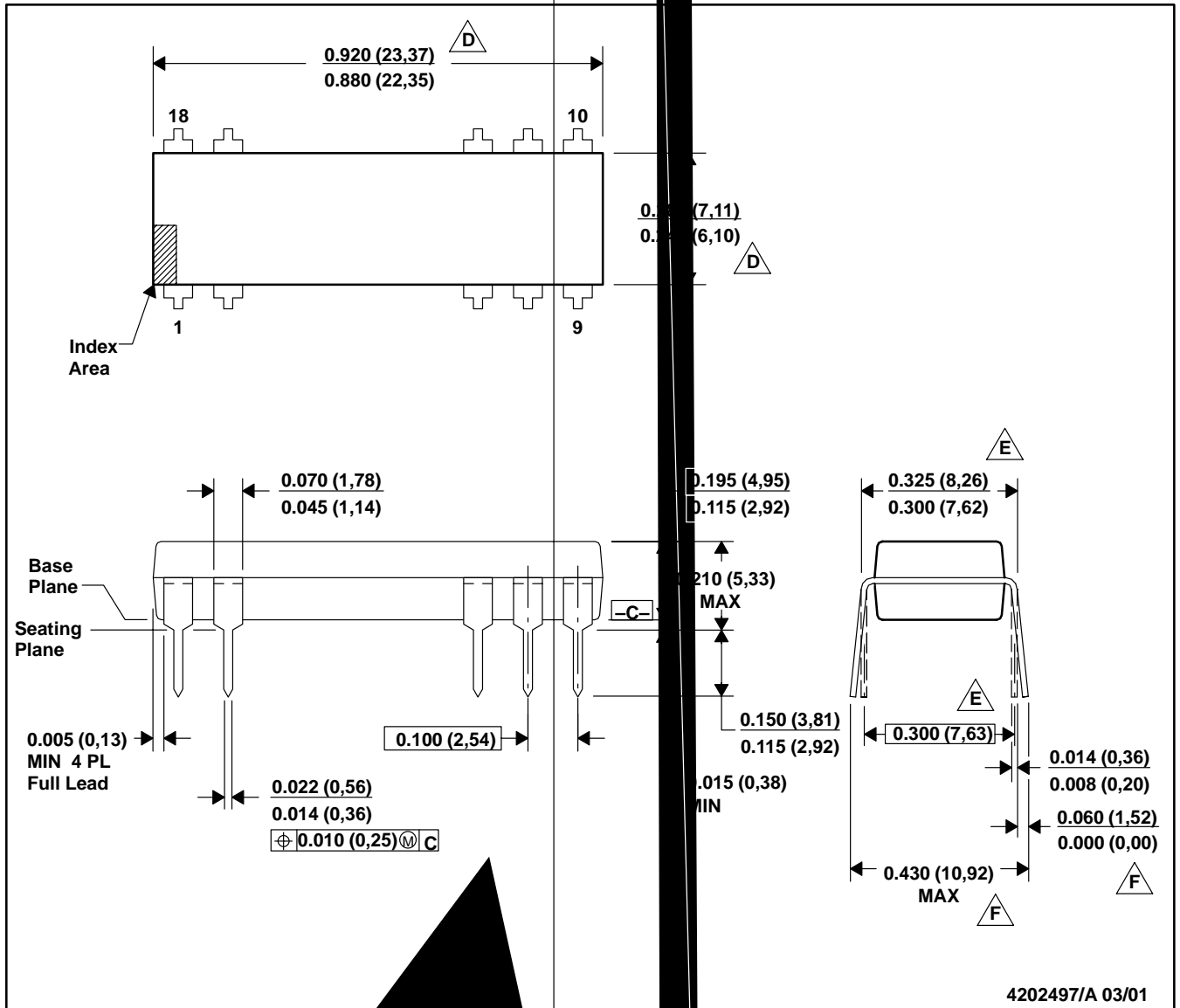
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DVB(R-PDSO-G12/28)

PLASTIC SMALL-OUTLINE





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